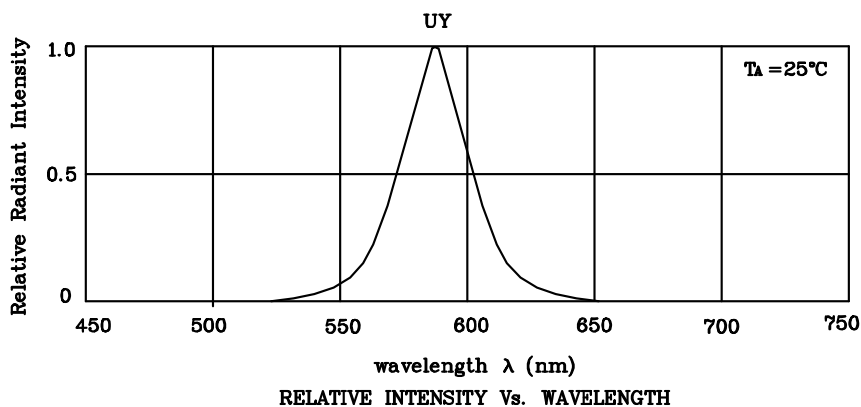
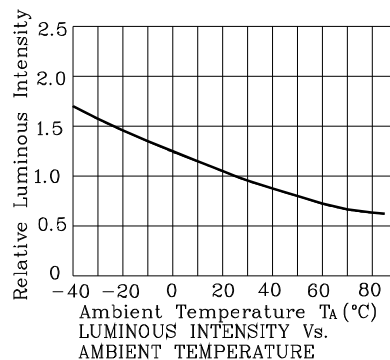
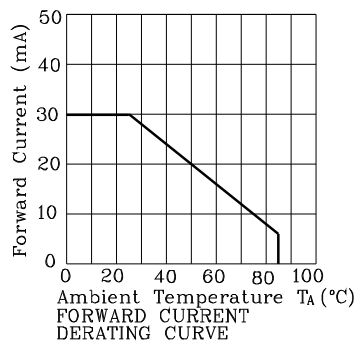
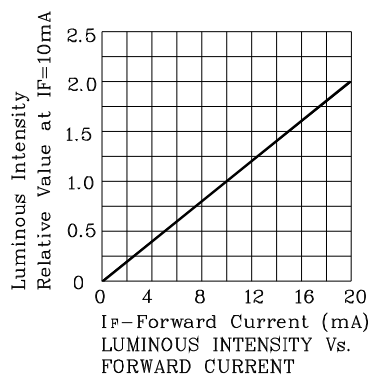
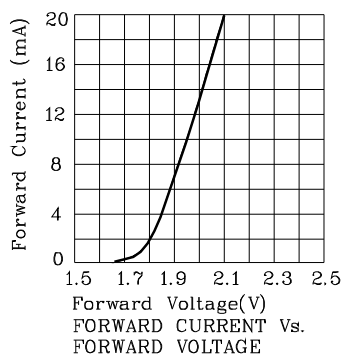


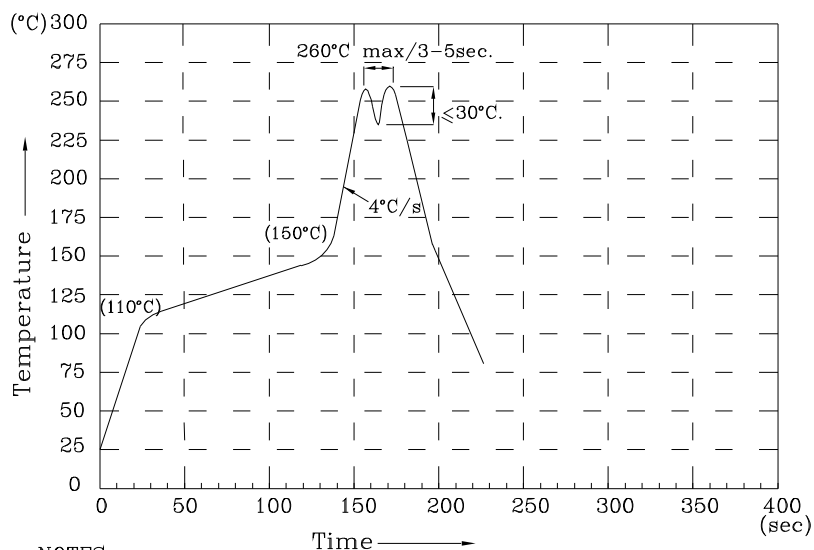
Part Number	Emitting Color	Emitting Material	Luminous Intensity (IF=10mA) ucd		Wavelength nm λ P	Description
			min.	typ.		
HUYX12DWB	Yellow	GaAsP/GaP	1900	7990	590	12 Segments Bargraph-Display
Published Date : MAR 17,2008		Drawing No : SDSA3723		V4	Checked : Shin Chi	P.1/4



❖ **UY**



Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature $245^{\circ}\text{C} \sim 260^{\circ}\text{C}$. The maximum soldering temperature should be less than 260°C .
2. Do not apply stress on epoxy resins when temperature is over 85°C .
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.

Remarks:

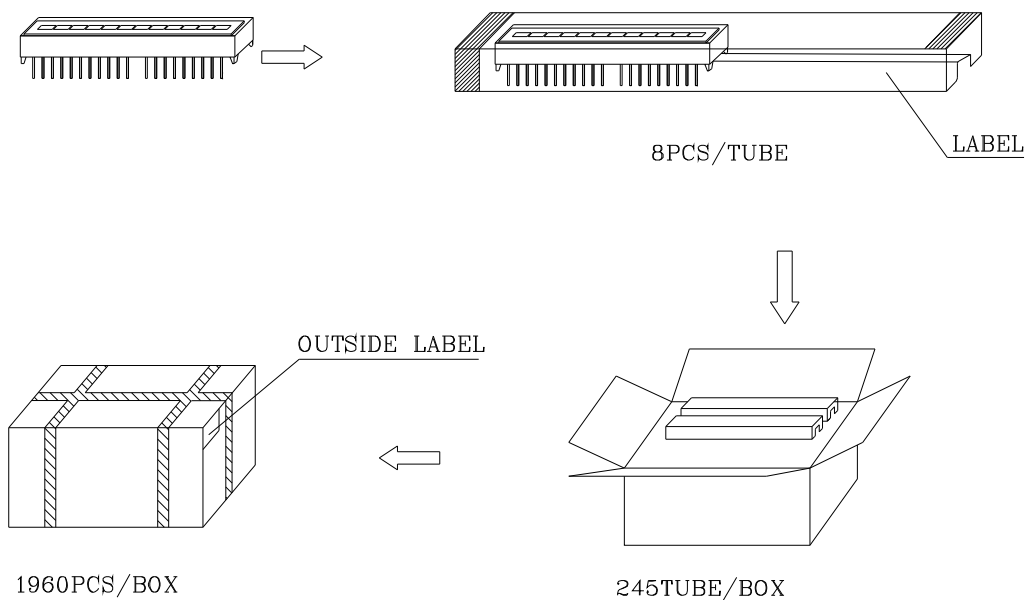
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: $\pm 1\text{nm}$
2. Luminous intensity / luminous flux: $\pm 15\%$
3. Forward Voltage: $\pm 0.1\text{V}$

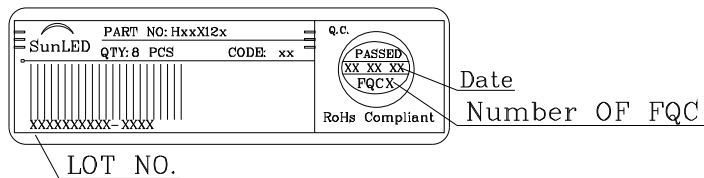
Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS

HUYX12DWB



Inside LABEL Paste On The IC-tube



Outside LABEL Paste On The Box

